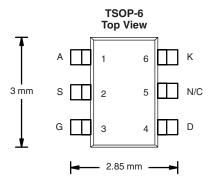


Vishay Siliconix

P-Channel 20-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)			
- 20	0.200 at V _{GS} = - 4.5 V	± 1.8			
	0.340 at V _{GS} = - 2.5 V	± 1.3			

SCHOTTKY PRODUCT SUMMARY						
V _{KA} (V)	V _F (V) Diode Forward Voltage	I _F (A)				
20	0.48 V at 0.5 A	0.5				



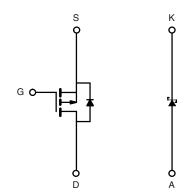
Ordering Information: Si3853DV-T1-E3 (Lead (Pb)-free)

Si3853DV-T1-GE3 (Lead (Pb)-free and Halogen-free)

- Halogen-free According to IEC 61249-2-21 Definition
- LITTLE FOOT[®] Plus
- Compliant to RoHS Directive 2002/95/EC



COMPLIANT HALOGEN FREE Available



P-Channel MOSFET

Parameter	Symbol	5 s	Steady State	Unit		
Drain-Source Voltage (MOSFET and Schottky)		V _{DS}	- 20		V	
Reverse Voltage (Schottky)		V _{KA}	20			
Gate-Source Voltage (MOSFET)		V _{GS}	± 12	± 12		
Continuous Drain Oursent (T. 150 °C) (MOOFF	T _A = 25 °C		± 1.8	± 1.6		
Continuous Drain Current ($T_J = 150 \text{ °C}$) (MOSFE	T _A = 70 °C	- I _D	± 1.5	± 1.2		
Pulsed Drain Current (MOSFET)		I _{DM}	± 7		•	
Continuous Source Current (MOSFET Diode Conduction) ^a		۱ _S	- 1.05	- 0.75	A	
Average Forward Current (Schottky)		١ _F	0.5			
Pulsed Foward Current (Schottky)	I _{FM}	7				
	T _A = 25 °C		1.15	0.83	W	
Maximum Power Dissipation (MOSFET) ^a	T _A = 70 °C	P _D	0.73	0.53		
	T _A = 25 °C		1.0	0.76		
Maximum Power Dissipation (Schottky) ^a	T _A = 70 °C	1	0.64	0.48		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55	to 150	°C		

a. Surface mounted on 1" x 1" FR4 board.

FEATURES

Si3853DV

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THERMAL RESISTANCE RATINGS							
Parameter		Device	Symbol	Typical	Maximum	Unit	
Junction-to-Ambient ^a	$t \le 5 s$	MOSFET	R _{thJA}	93	110	°C/W	
		Schottky		103	125		
	Steady State	MOSFET		130	150		
		Schottky		140	165		
Junction-to-Foot	Steady State	MOSFET	R _{thJF}	75	90		
		MOSFET		80	95	1	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

Parameter	Symbol	I Test Conditions Min. Ty		Тур.	Max.	Unit
Static	•		•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.5			V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA
Zara Cata Valtaga Drain Current		V _{DS} = - 16 V, V _{GS} = 0 V			- 1	μA
Zero Gate Voltage Drain Current	IDSS	V_{DS} = - 16 V, V_{GS} = 0 V, T_{J} = 75 °C			- 10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge$ - 5 V, V_{GS} = - 4.5 V	- 5			А
Ducia Courses On Otata Desistance	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 1.8 A		0.160	0.200	
Drain-Source On-State Resistance ^a		V _{GS} = - 2.5 V, I _D = - 1.0 A		0.280	0.340	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 5 V, I _D = - 1.8 A		3.6		S
Diode Forward Voltage ^a	V _{SD}	I _S = - 1.05 V, V _{GS} = 0 V		- 0.83	- 1.10	V
Dynamic ^b						
Total Gate Charge	Qg			2.7	4.0	
Gate-Source Charge	Q _{gs}	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -1.8 \text{ A}$		0.4		nC
Gate-Drain Charge	Q _{gd}	1 – – – – – – – – – – – – – – – – – – –		0.6		1
Turn-On Delay Time	t _{d(on)}			11	17	
Rise Time	t _r	V _{DD} = - 10 V, R _L = 10 Ω		34	50	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 1 Å, V_{GEN} = - 4.5 V, R_g = 6 Ω		19	30	ns
Fall Time	t _f	1 1		24	36	
Body Diode Reverse Recovery Time	t _{rr}	I _F = - 1.05 A, dl/dt = 100 A/μs		20	40	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

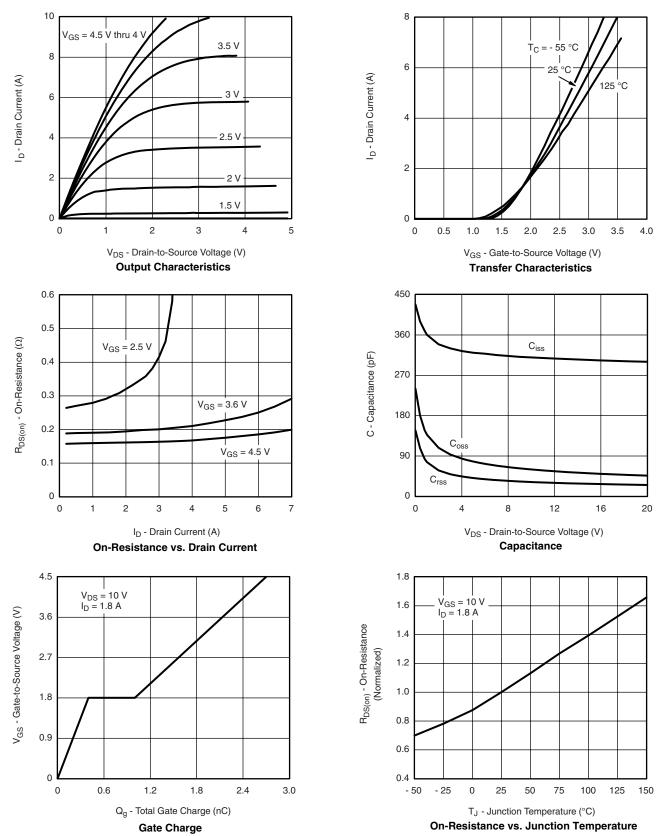
b. Guaranteed by design, not subject to production testing.

SCHOTTKY SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
	V _F	I _F = 0.5 A		0.42	0.48	v		
Forward Voltage Drop		I _F = 0.5 A, T _J = 125 °C		0.33	0.4			
		V _R = 20 V		0.002	0.100	mA		
Maximum Reverse Leakage Current	I _{rm}	V _R = 20 V, T _J = 75 °C		0.06	1			
		$V_{R} = 20 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$		1.5	10			
Junction Capacitance	CT	V _R = 10 V		31		pF		

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

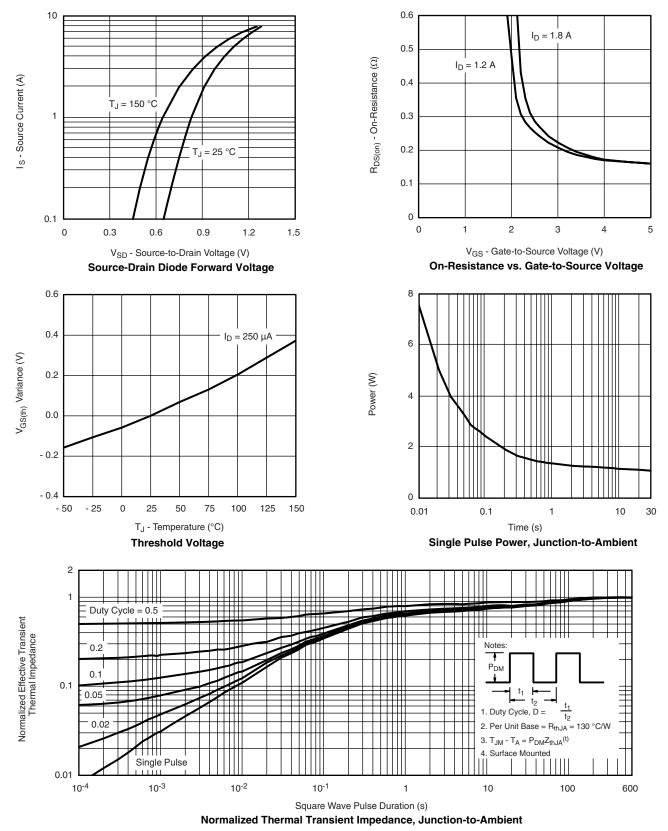


MOSFET TYPICAL CHARACTERISTICS T_A = 25 °C, unless otherwise noted



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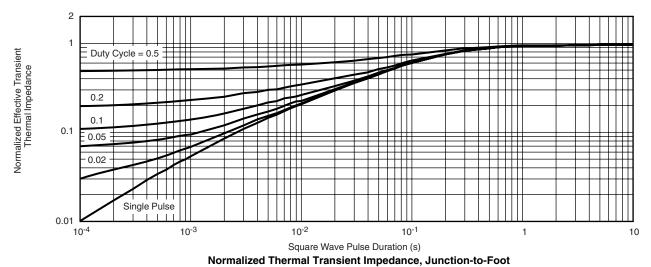
MOSFET TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted





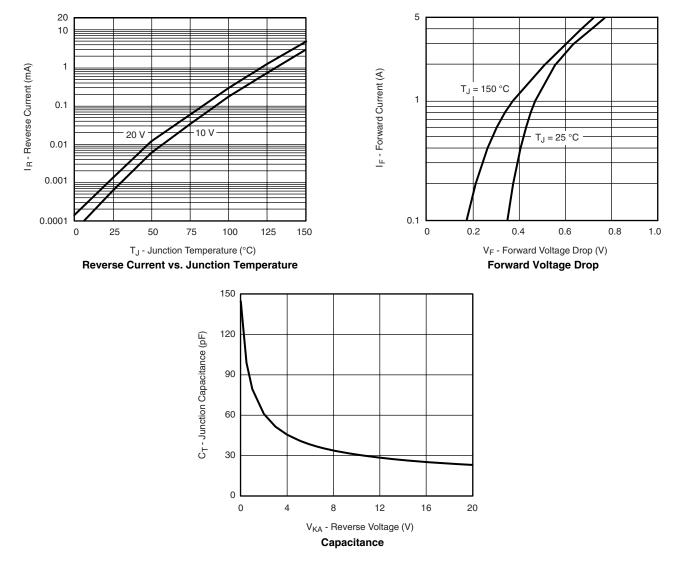
Si3853DV

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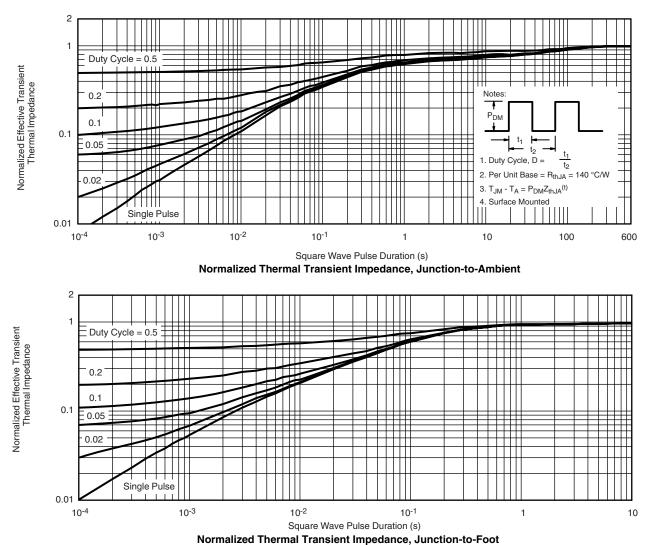
MOSFET TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted





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SCHOTTKY TYPICAL CHARACTERISTICS $\ensuremath{\mathsf{T}_{\mathsf{A}}}\xspace = 25\ensuremath{\,^\circ\mathsf{C}}\xspace,$ unless otherwise noted

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